

# SN54LV164, SN74LV164 8-BIT PARALLEL-OUT SERIAL SHIFT REGISTERS

SCLS191B – FEBRUARY 1993 – REVISED APRIL 1996

- **EPIC™ (Enhanced-Performance Implanted CMOS) 2- $\mu$  Process**
- **Typical  $V_{OLP}$  (Output Ground Bounce) < 0.8 V at  $V_{CC}$ ,  $T_A = 25^\circ\text{C}$**
- **Typical  $V_{OHV}$  (Output  $V_{OH}$  Undershoot) > 2 V at  $V_{CC}$ ,  $T_A = 25^\circ\text{C}$**
- **ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model ( $C = 200$  pF,  $R = 0$ )**
- **Latch-Up Performance Exceeds 250 mA Per JEDEC Standard JESD-17**
- **Package Options Include Plastic Small-Outline (D), Shrink Small-Outline (DB), Thin Shrink Small-Outline (PW), Ceramic Flat (W) Packages, Chip Carriers (FK), and (J) 300-mil DIPs**

## description

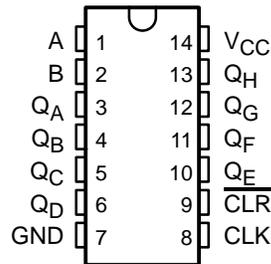
These 8-bit parallel-out serial shift registers are designed for 2.7-V to 5.5-V  $V_{CC}$  operation.

The 'LV164 feature AND-gated serial (A and B) inputs and an asynchronous clear ( $\overline{\text{CLR}}$ ) input. The gated serial inputs permit complete control over incoming data as a low at either input inhibits entry of the new data and resets the first flip-flop to the low level at the next clock pulse. A high-level input enables the other input, which then determines the state of the first flip-flop. Data at the serial inputs can be changed while the clock is high or low, provided the minimum setup time requirements are met. Clocking occurs on the low-to-high-level transition of the clock (CLK) input.

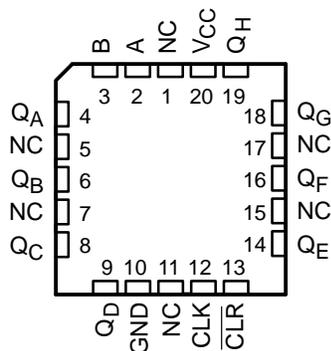
The SN74LV164 is available in TI's shrink small-outline package (DB), which provides the same I/O pin count and functionality of standard small-outline packages in less than half the printed-circuit-board area.

The SN54LV164 is characterized for operation over the full military temperature range of  $-55^\circ\text{C}$  to  $125^\circ\text{C}$ . The SN74LV164 is characterized for operation from  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .

SN54LV164 . . . J OR W PACKAGE  
SN74LV164 . . . D, DB, OR PW PACKAGE  
(TOP VIEW)



SN54LV164 . . . FK PACKAGE  
(TOP VIEW)



NC – No internal connection



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**TEXAS  
INSTRUMENTS**

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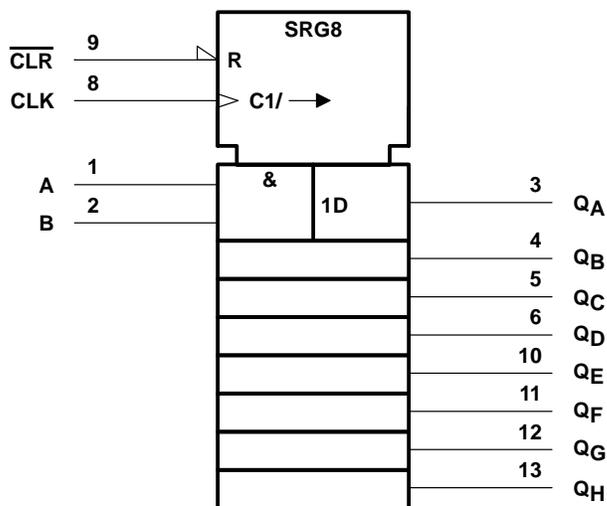
FUNCTION TABLE

INPUTS				OUTPUTS		
CLR	CLK	A	B	Q <sub>A</sub>	Q <sub>B</sub> ... Q <sub>H</sub>	
L	X	X	X	L	L	L
H	L	X	X	Q <sub>A0</sub>	Q <sub>B0</sub>	Q <sub>H0</sub>
H	↑	H	H	H	Q <sub>An</sub>	Q <sub>Gn</sub>
H	↑	L	X	L	Q <sub>An</sub>	Q <sub>Gn</sub>
H	↑	X	L	L	Q <sub>An</sub>	Q <sub>Gn</sub>

Q<sub>A0</sub>, Q<sub>B0</sub>, Q<sub>H0</sub> = the level of Q<sub>A</sub>, Q<sub>B</sub>, or Q<sub>H</sub>, respectively, before the indicated steady-state inputs conditions were established

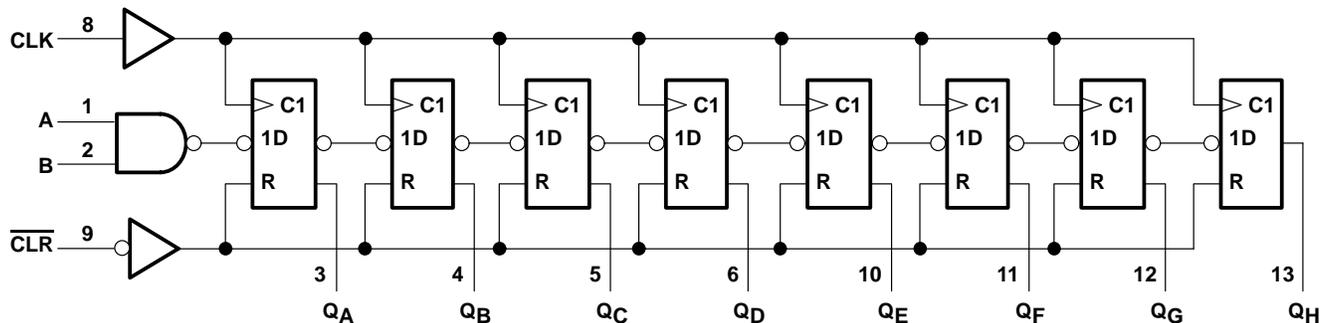
Q<sub>An</sub>, Q<sub>Gn</sub> = the level of Q<sub>A</sub> or Q<sub>G</sub> before the most recent ↑ transition of the clock: indicates a 1-bit shift

## logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, DB, J, PW, and W packages.

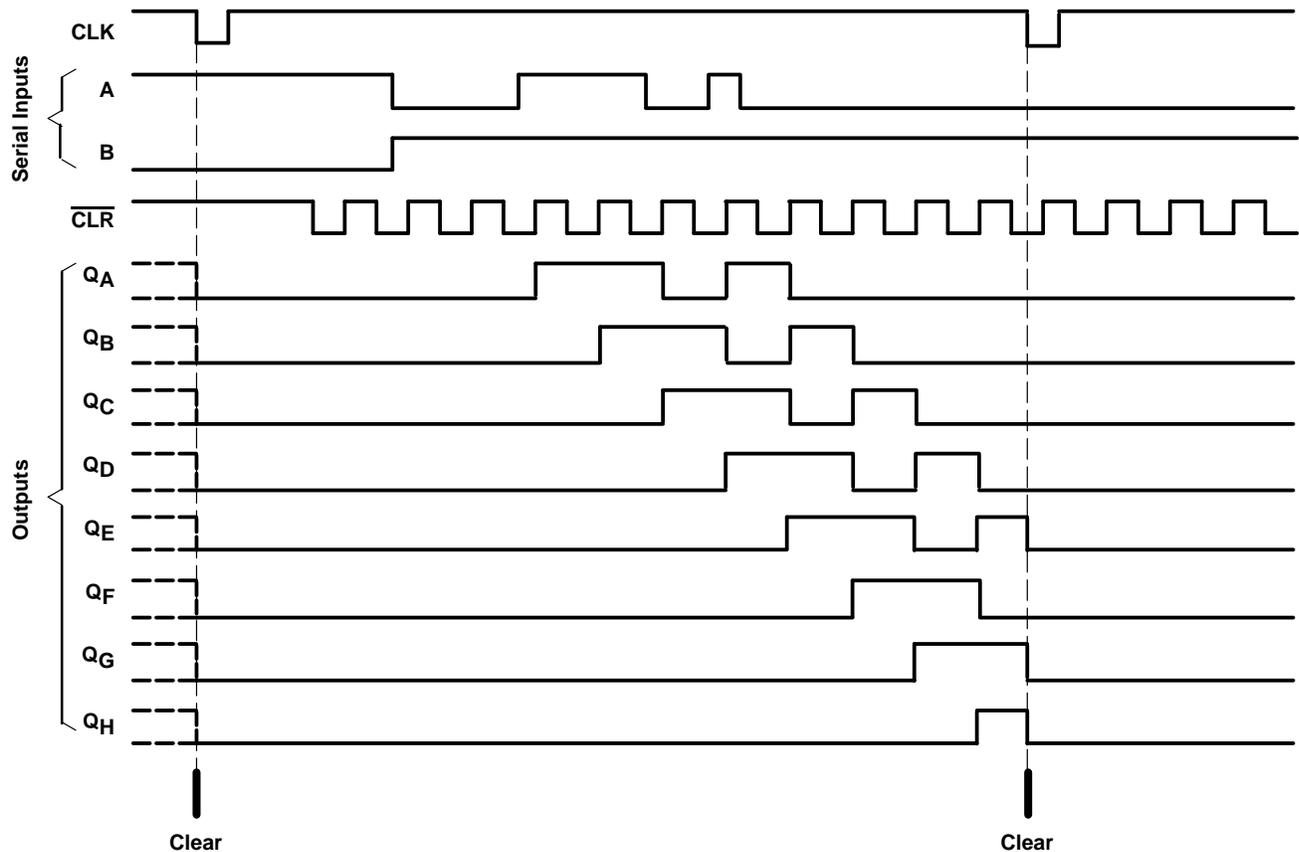
## logic diagram (positive logic)



# SN54LV164, SN74LV164 8-BIT PARALLEL-OUT SERIAL SHIFT REGISTERS

SCLS191B – FEBRUARY 1993 – REVISED APRIL 1996

## typical clear, shift, and clear sequences



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$ .....	-0.5 V to 7 V
Input voltage range, $V_I$ (see Note 1) .....	-0.5 V to $V_{CC} + 0.5$ V
Output voltage range, $V_O$ (see Notes 1 and 2) .....	-0.5 V to $V_{CC} + 0.5$ V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) .....	$\pm 20$ mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) .....	$\pm 50$ mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ ) .....	$\pm 25$ mA
Continuous current through $V_{CC}$ or GND .....	$\pm 50$ mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 3): D package .....	1.25 W
DB or PW package .....	0.5 W
Storage temperature range, $T_{stg}$ .....	$-65^\circ\text{C}$ to $150^\circ\text{C}$

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
 2. This value is limited to 7 V maximum.  
 3. The maximum package power dissipation is calculated using a junction temperature of  $150^\circ\text{C}$  and a board trace length of 750 mils.

# SN54LV164, SN74LV164

## 8-BIT PARALLEL-OUT SERIAL SHIFT REGISTERS

SCLS191B – FEBRUARY 1993 – REVISED APRIL 1996

### recommended operating conditions (see Note 4)

		SN54LV164		SN74LV164		UNIT
		MIN	MAX	MIN	MAX	
V <sub>CC</sub>	Supply voltage	2.7	5.5	2.7	5.5	V
V <sub>IH</sub>	High-level input voltage	V <sub>CC</sub> = 2.7 V to 3.6 V		2		V
		V <sub>CC</sub> = 4.5 V to 5.5 V		3.15		
V <sub>IL</sub>	Low-level input voltage	V <sub>CC</sub> = 2.7 V to 3.6 V		0.8		V
		V <sub>CC</sub> = 4.5 V to 5.5 V		1.65		
V <sub>I</sub>	Input voltage	0	V <sub>CC</sub>	0	V <sub>CC</sub>	V
V <sub>O</sub>	Output voltage	0	V <sub>CC</sub>	0	V <sub>CC</sub>	V
I <sub>OH</sub>	High-level output current	V <sub>CC</sub> = 2.7 V to 3.6 V		-6		mA
		V <sub>CC</sub> = 4.5 V to 5.5 V		-12		
I <sub>OL</sub>	Low-level output current	V <sub>CC</sub> = 2.7 V to 3.6 V		6		mA
		V <sub>CC</sub> = 4.5 V to 5.5 V		12		
Δt/Δv	Input transition rise or fall rate	0	100	0	100	ns/V
T <sub>A</sub>	Operating free-air temperature	-55	125	-40	85	°C

NOTE 4: Unused inputs must be held high or low to prevent them from floating.

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V <sub>CC</sub> †	SN54LV164			SN74LV164			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
V <sub>OH</sub>	I <sub>OH</sub> = -100 μA	MIN to MAX	V <sub>CC</sub> - 0.2			V <sub>CC</sub> - 0.2			V
	I <sub>OH</sub> = -6 mA	3 V	2.4			2.4			
	I <sub>OH</sub> = -12 mA	4.5 V	3.6			3.6			
V <sub>OL</sub>	I <sub>OL</sub> = 100 μA	MIN to MAX	0.2			0.2			V
	I <sub>OL</sub> = 6 mA	3 V	0.4			0.4			
	I <sub>OL</sub> = 12 mA	4.5 V	0.55			0.55			
I <sub>I</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND	3.6 V	±1			±1			μA
		5.5 V	±1			±1			
I <sub>CC</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0	3.6 V	20			20			μA
		5.5 V	20			20			
ΔI <sub>CC</sub>	One input at V <sub>CC</sub> - 0.6 V, Other inputs at V <sub>CC</sub> or GND	3 V to 3.6 V	500			500			μA
C <sub>i</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND	3.3 V	2.5			2.5			pF
		5 V	3			3			

† For conditions shown as MIN or MAX, use the appropriate values under recommended operating conditions.

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SCLS191B – FEBRUARY 1993 – REVISED APRIL 1996

**timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)**

		SN54LV164						UNIT
		V <sub>CC</sub> = 5.5 V ± 0.5 V		V <sub>CC</sub> = 3.3 V ± 0.3 V		V <sub>CC</sub> = 2.7 V		
		MIN	MAX	MIN	MAX	MIN	MAX	
f <sub>clock</sub>	Clock frequency	0	40	0	35	0	30	MHz
t <sub>w</sub>	Pulse duration	CLR low	14		16		18	ns
		CLK high or low	14		16		18	
t <sub>su</sub>	Setup time, data before CLK↑	Data	8		10		12	ns
		CLR inactive	5		6		7	
t <sub>h</sub>	Hold time, data after CLK↑	3		3		3	ns	

**timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)**

		SN74LV164						UNIT
		V <sub>CC</sub> = 5.5 V ± 0.5 V		V <sub>CC</sub> = 3.3 V ± 0.3 V		V <sub>CC</sub> = 2.7 V		
		MIN	MAX	MIN	MAX	MIN	MAX	
f <sub>clock</sub>	Clock frequency	0	40	0	35	0	30	MHz
t <sub>w</sub>	Pulse duration	CLR low	14		16		18	ns
		CLK high or low	14		16		18	
t <sub>su</sub>	Setup time, data before CLK↑	Data	8		10		12	ns
		CLR inactive	5		6		7	
t <sub>h</sub>	Hold time, data after CLK↑	3		3		3	ns	

**switching characteristics over recommended operating free-air temperature range, C<sub>L</sub> = 50 pF (unless otherwise noted) (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54LV164						UNIT		
			V <sub>CC</sub> = 5.5 V ± 0.5 V			V <sub>CC</sub> = 3.3 V ± 0.3 V				V <sub>CC</sub> = 2.7 V	
			MIN	TYP	MAX	MIN	TYP	MAX		MIN	MAX
f <sub>max</sub>			40	90		35	75		30	MHz	
t <sub>pd</sub>	CLK	Q		10	20		14	26		32	ns
t <sub>PHL</sub>	CLR	Q		12	20		16	26		32	ns

**switching characteristics over recommended operating free-air temperature range, C<sub>L</sub> = 50 pF (unless otherwise noted) (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN74LV164						UNIT		
			V <sub>CC</sub> = 5.5 V ± 0.5 V			V <sub>CC</sub> = 3.3 V ± 0.3 V				V <sub>CC</sub> = 2.7 V	
			MIN	TYP	MAX	MIN	TYP	MAX		MIN	MAX
f <sub>max</sub>			40	90		35	75		30	MHz	
t <sub>pd</sub>	CLK	Q		10	20		14	26		32	ns
t <sub>PHL</sub>	CLR	Q		12	20		16	26		32	ns

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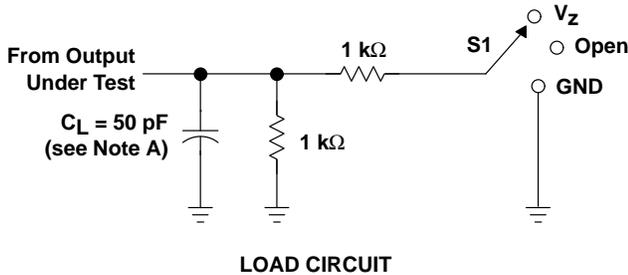
# SN54LV164, SN74LV164 8-BIT PARALLEL-OUT SERIAL SHIFT REGISTERS

SCLS191B – FEBRUARY 1993 – REVISED APRIL 1996

operating characteristics,  $T_A = 25^\circ\text{C}$

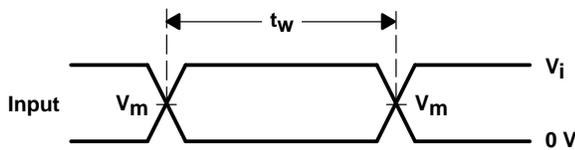
PARAMETER		TEST CONDITIONS	TYP	TYP	UNIT
$C_{pd}$	Power dissipation capacitance	$C_L = 50\text{ pF}, f = 10\text{ MHz}$	3.3 V	74	pF
			5 V	75	

## PARAMETER MEASUREMENT INFORMATION

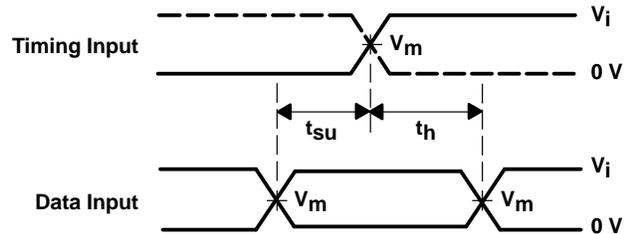


TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	$V_Z$
$t_{PHZ}/t_{PZH}$	GND

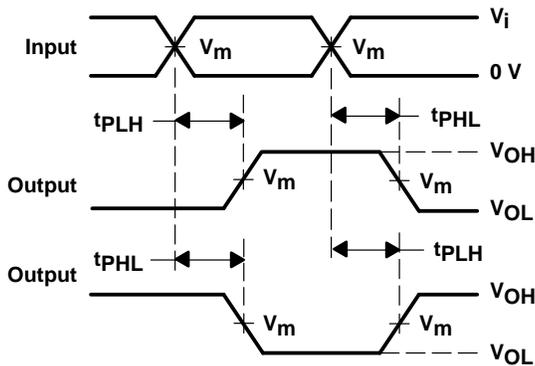
WAVEFORM CONDITION	$V_{CC} = 4.5\text{ V}$ to $5.5\text{ V}$	$V_{CC} = 2.7\text{ V}$ to $3.6\text{ V}$
$V_m$	$0.5 \times V_{CC}$	1.5 V
$V_i$	$V_{CC}$	2.7 V
$V_Z$	$2 \times V_{CC}$	6 V



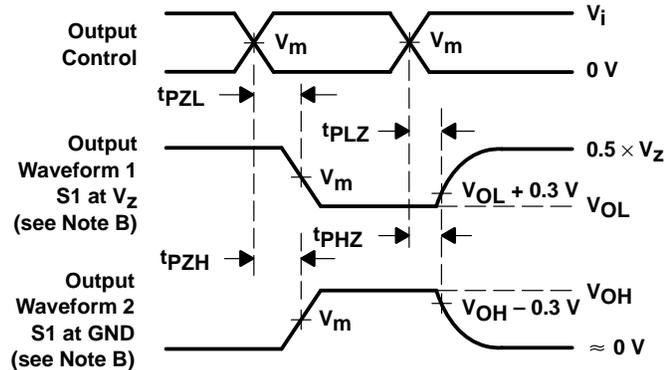
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r \leq 2.5\text{ ns}$ ,  $t_f \leq 2.5\text{ ns}$ .
  - The outputs are measured one at a time with one transition per measurement.
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 1. Load Circuit and Voltage Waveforms

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